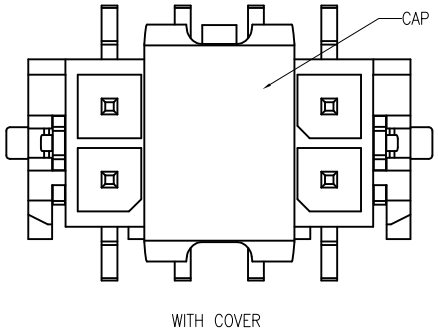
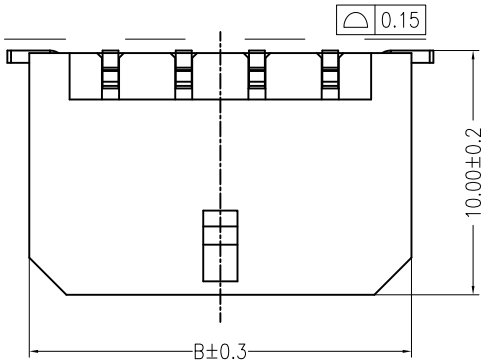
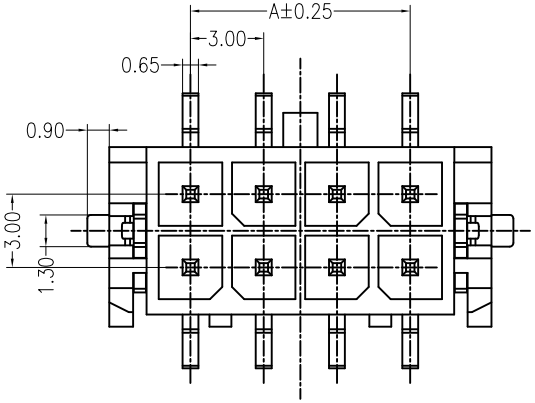
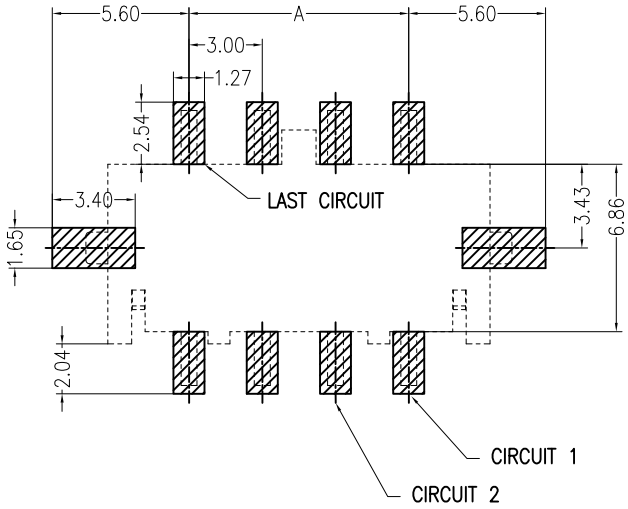
REV	DESCRIPTION	DESIGN	DATE
A0			



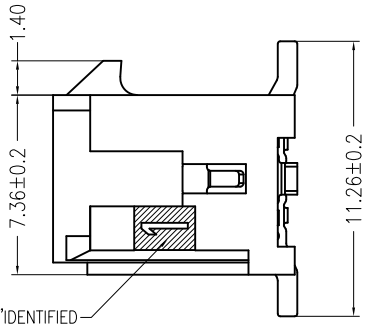
WITH COVER



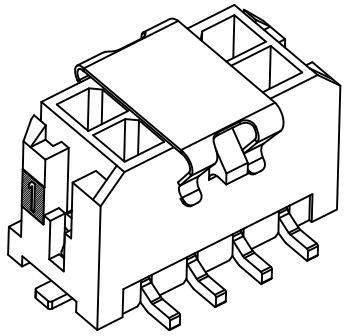




PCB LAYOUT(Tolerance:±0.05)



CIRCUIT"1"IDENTIFIED ON THIS SURFACE (APPROX.LOCATION SHOWN FOR REF.)



PIN	DIM A	DIM B
2x2	3.00	9.65
2x3	6.00	12.65
2x4	9.00	15.65
2x5	12.00	18.65
2x6	15.00	21.65
2x7	18.00	24.65
2x8	21.00	27.65
2x9	24.00	30.65
2x10	27.00	33.65
2x11	30.00	36.65
2x12	33.00	39.65

Specifications:

Contact resistance:≤10mΩ
Insulation resistance:≥1000MΩ
Rated voltage:250V AC DC
Rated current:5.0A AC DC
Withstand Voltage: 1000V AC/minute
Temperature Range:−25℃～ +85℃
Housing:LCP UL94V−0,BLACK
Contacts:Brass/MATTE Sn−plated
Solder Tabs:Brass/MATTE Sn−plated

ORDER INFORMATION:

A3001AWV−2**−F9KB3−R−X

- PART No.
- No.OF CIRCUITS: 02−24
- PLASTIC MATERIAL: F9K=LCP
- PLATING: B=MATTE Sn
- Metal code: 3=Brass
- PACKAGING: R=REEL
- SPECIAL CODE: X=Cap

GENERAL TOLERANCE			
X.	±0.50	X.	±5°
X.X	±0.30	X.X	±2°
X.XX	±0.20	X.XX	±1°
UNITS: mm			

浙江创都电子科技有限公司

USE: CUSTOMER
APPD:
CHKD:
DR:

料号编码：A3001AWV-2**-F9KB3-R-X

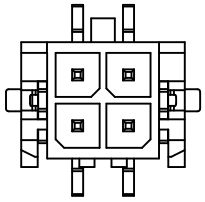
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模号：GK

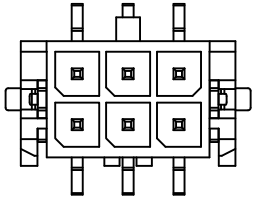
SCALE 1 : 1

SHEET 1 / 2

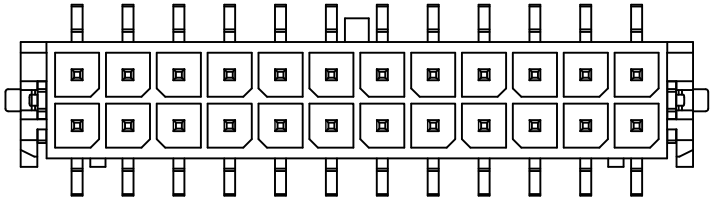
REV	DESCRIPTION	DESIGN	DATE
A0			



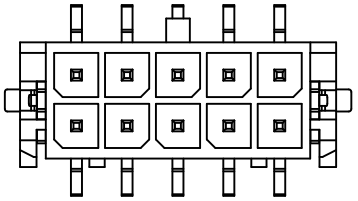
2x2P



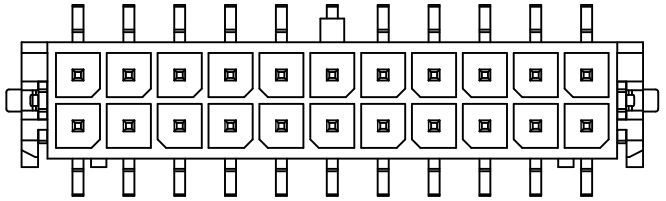
2x3P



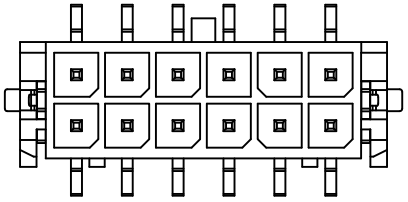
2x12P



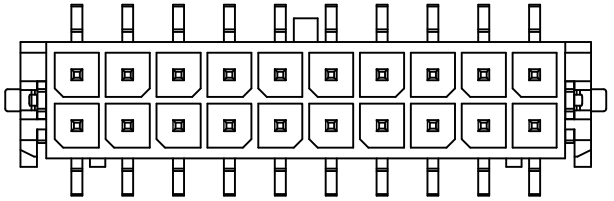
2x5P



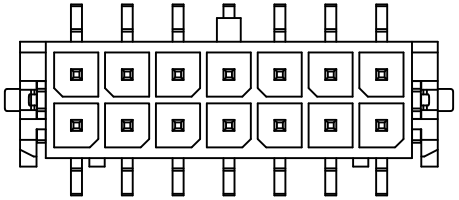
2x11P



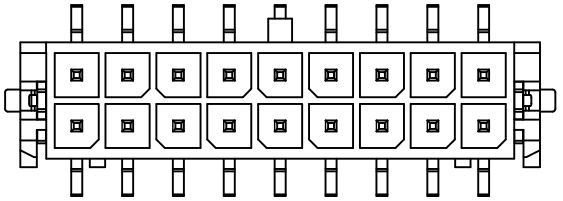
2x6P



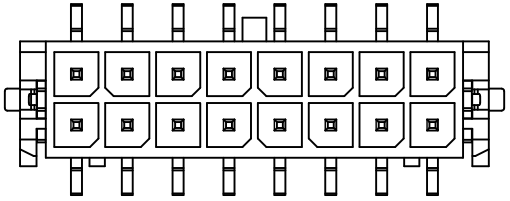
2x10P



2x7P



2x9P



2x8P

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GENERAL TOLERANCE	
X. ±0.50	X. ±5°
X.X ±0.30	X.X ±2°
X.XX ±0.20	X.XX ±1°

UNITS: mm

USE: CUSTOMER

APPD:

CHKD:

DR:

TITLE: 3.0 Pitch Wafer 180° SMT

PART NO.:

DWG NO.:

SCALE 1 : 1

SHEET 2 / 2